

The Separate Customs Territory of Taiwan, Penghu, Kinmen and Matsu--Attachment B

With respect to any product described in or for Attachment B to the Annex to the Ministerial Declaration on Trade in Information Technology Products (WT/MIN(96)/16), to the extent not specifically provided for in this Schedule, the customs duties on such product, as well any other duties and charges of any kind (within the meaning of Article II:1(b) of the General Agreement on Tariffs and Trade 1994), shall be bound and eliminated, as set forth in paragraph 2(a) of the Annex to the Declaration, wherever the product is classified.

<u>Description</u>	<u>HS</u>
Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	ex70171000
Chemical vapor deposition apparatus for semiconductor production	ex84198990,ex84798990
Parts of chemical vapor deposition apparatus for semiconductor production	ex84199000,ex84799090
Apparatus for stripping or cleaning semiconductor wafers	84569100
Lasercutters for cutting contacting tracks in semiconductor production by laser beam	ex84569990,ex84561000
Machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	ex84641000
Parts for machines for sawing monocrystal semiconductor boules into slices, or wafers into chips	ex84669100
Parts of dicing machines for scribing or scoring semiconductor wafers	ex84669100
Parts of lasercutters for cutting contacting tracks in semiconductor production by laser beam	ex84669300
Parts of apparatus for stripping or cleaning semiconductor wafers	ex84669300
Encapsulation equipment for assembly of semiconductors	ex84771000
Parts of encapsulation equipment	ex84779000
Automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	ex84795090
Apparatus for physical deposition by sputtering on semiconductor wafers	ex85431100,ex84798990
Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	ex84798990
Die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	ex84798990
Machines for bending, folding and straightening semiconductor leads	ex84798990
Physical deposition apparatus for semiconductor production	ex84798990
Spinners for coating photographic emulsions on semiconductor wafers	ex84798990

<u>Description</u>	<u>HS</u>
Part of apparatus for physical deposition by sputtering on semiconductor wafers	ex84799090,ex85439000
Parts for die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	ex84799090
Parts for spinners for coating photographic emulsions on semiconductor wafers	ex84799090
Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	ex84799090
Parts of automated machines for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	ex84799090
Parts of encapsulation equipment for assembly of semiconductors	ex84779000
Parts of machines for bending, folding and straightening semiconductor leads	ex84799090
Parts of physical deposition apparatus for semiconductor production	ex84799090
Apparatus for rapid heating of semiconductor wafers	ex85143000
Parts of apparatus for rapid heating of wafers	ex85149000
Wafer probers	ex85369090
Optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	ex90111000
Photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	ex90112000
Parts and accessories of optical stereoscopic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	ex90119000
Parts and accessories of photomicrographic microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	ex90119000
Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	ex90121000
Parts and accessories of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	ex90129000
Pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	ex90172010

<u>Description</u>	<u>HS</u>
Parts and accessories for pattern generating apparatus of a kind used for producing masks or reticles from photoresist coated substrates	ex90179090
Parts of such pattern generating apparatus	ex90179090
Computers: automatic data processing machines capable of 1) storing the processing program or programs and at least the data immediately necessary for the execution of the program; 2) being freely programmed in accordance with the requirements of the user; 3) performing arithmetical computations specified by the user; and 4) executing, without human intervention, a processing program which requires them to modify their execution, by logical decision during the processing run. The agreement covers such automatic data processing machines whether or not they are able to receive and process with the assistance of central processing unit telephony signals, television signals, or other analogue or digitally processed audio or video signals. Machines performing a specific function other than data processing, or incorporating or working in conjunction with an automatic data processing machine, and not otherwise specified under Attachment A or B, are not covered by this agreement.	84711000,84713000,84714100,84714900,84715000,84716010,84716020,84716030,84716090,84717010,84717090,84718000,84719010,84719020,84719030,84719040,84719090
Electric amplifiers when used as repeaters in line telephony products falling within this agreement, and parts thereof	ex85184000,ex85189000
Flat panel display devices (including LCD, Electro Luminescence, Plasma, Vacuum-Fluorescence and other technologies) for products falling within this agreement, and parts thereof.	85312000,84716090,ex85319000,90138030,ex90139000
Network equipment: Local Area Network (LAN) and Wide Area Network (WAN) apparatus, including those products dedicated for use solely or principally to permit the interconnection of automatic data processing machines and units thereof for a network that is used primarily for the sharing of resources such as central processor units, data storage devices and input or output units - including adapters, hubs, in-line repeaters, converters, concentrators, bridges and routers, and printed circuit assemblies for physical incorporation into automatic data processing machines and units thereof.	84715000,84716010,84716020,84716030,84716090,84718000,84733010,84733021,84733029
Monitors : display units of automatic data processing machines with a cathode ray tube with a dot screen pitch smaller than 0,4 mm not capable of receiving and processing television signals or other analogue or digitally processed audio or video signals without assistance of a central processing unit of a computer as defined in this agreement. The agreement does not, therefore, cover televisions, including high definition televisions.	84716090
Optical disc storage units, for automatic data processing machines (including CD drives and DVD-drives), whether or not having the capability of writing/recording as well as reading, whether or not in their own housings.	84717010,84717090
Paging alert devices, and parts thereof .	ex85279000,ex85299090

<u>Description</u>	<u>HS</u>
Plotters whether input or output units of HS heading No 8471 or drawing or drafting machines of HS heading No 9017.	84715000,84716010,84716020,84716030,84716090,ex90171000,ex90172010,ex90172090
Printed Circuit Assemblies for products falling within this agreement, including such assemblies for external connections such as cards that conform to the PCMCIA standard. Such printed circuit assemblies consist of one or more printed circuits of heading 8534 with one or more active elements assembled thereon, with or without passive elements "Active elements" means diodes, transistors, and similar semiconductor devices, whether or not photosensitive, of heading 8541, and integrated circuits and micro assemblies of heading 8542.	84733010,84733021,84733029,84735010,84735020,84735090,ex85229020(printed circuit assemblies for telephone answering machines)
Projection type flat panel display units used with automatic data processing machines which can display digital information generated by the central processing unit.	84716090
Proprietary format storage devices including media therefor for automatic data processing machines, with or without removable media and whether magnetic, optical or other technology, including Bernoulli Box, Syquest, or Zipdrive cartridge storage units.	84716090,84717010,84717090,85239010,85239090,85243100,85249100
Multimedia upgrade kits for automatic data processing machines, and units thereof, put up for retail sale, consisting of, at least, speakers and/or microphones as well as a printed circuit assembly that enables the ADP machines and units thereof to process audio signals (sound cards).	84733010,84733021,84733029,ex85181000,ex85182990
Set top boxes which have a communication function: a microprocessor-based device incorporating a modem for gaining access to the Internet, and having a function of interactive information exchange	ex85175010,ex85175090,ex85252030,ex85252090
Encapsulation equipment for assembly of semiconductors	ex84798990
Apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	ex85433000
Parts of apparatus for wet etching, developing, stripping or cleaning semiconductor wafers and flat panel displays	ex85439000